



NCE N-Channel Super Trench Power MOSFET

Description

The NCEP1260F uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

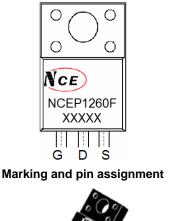
- V_{DS} =120V,I_D =60A
 - $R_{DS(ON)}$ =10m Ω (typical) @ V_{GS}=10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram

O D



TO-220F top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP1260F	NCEP1260F	TO-220F	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	120	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	60	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	42.4	A
Pulsed Drain Current	I _{DM}	240	A
Maximum Power Dissipation	PD	30	W
Derating factor		0.2	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	290	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	5	°C/W	
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NCEP1260F

Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	120		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =120V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =30A	-	10	11	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =30A	-	40	-	S
Dynamic Characteristics (Note4)			·			
Input Capacitance	C _{lss}		-	2380	-	PF
Output Capacitance	C _{oss}	V_{DS} =60V, V_{GS} =0V,	-	345	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	12.4	-	PF
Switching Characteristics (Note 4)	· ·		•			
Turn-on Delay Time	t _{d(on)}		-	24	-	nS
Turn-on Rise Time	tr	V _{DD} =50V,I _D =30A	-	9.7	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	38	-	nS
Turn-Off Fall Time	t _f		-	12.4	-	nS
Total Gate Charge	Qg	V -00V(1 -20A	-	38		nC
Gate-Source Charge	Q _{gs}	V _{DS} =60V,I _D =30A, V _{GS} =10V	-	13.8		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	11		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =60A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	60	A
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-	58		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	138		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

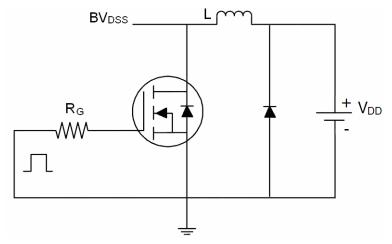
5. EAS condition : Tj=25 $^\circ \!\! C$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25\Omega



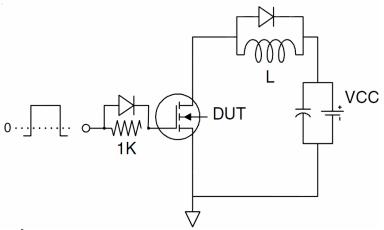
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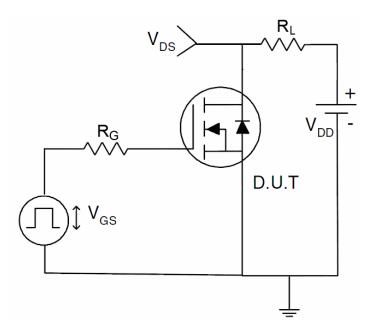
Test Circuit 1) E_{AS} test Circuit



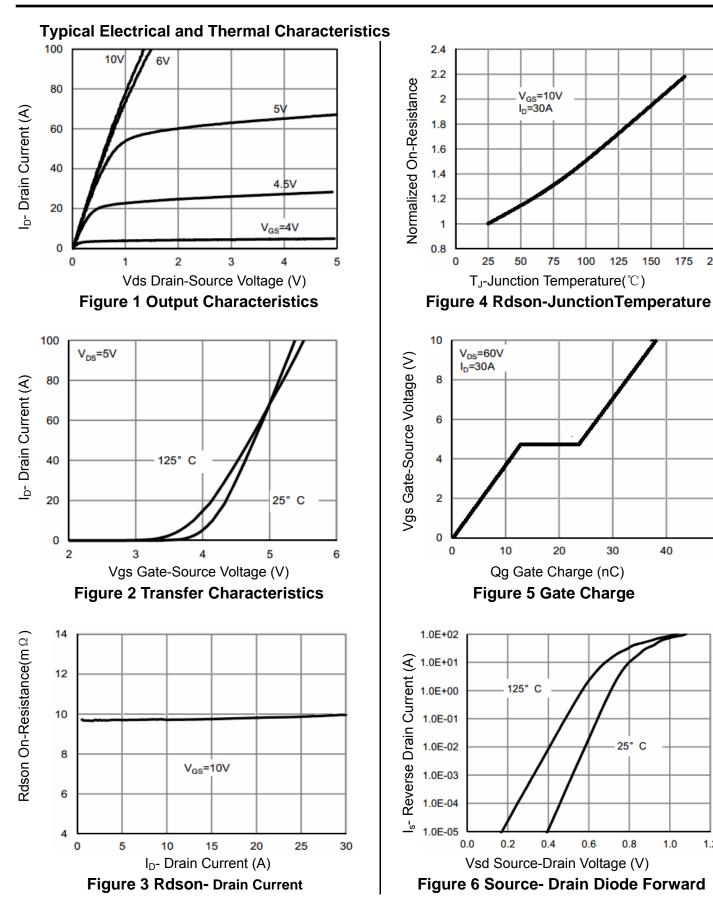
2) Gate charge test Circuit



3) Switch Time Test Circuit







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Pb Free Product

NCEP1260F

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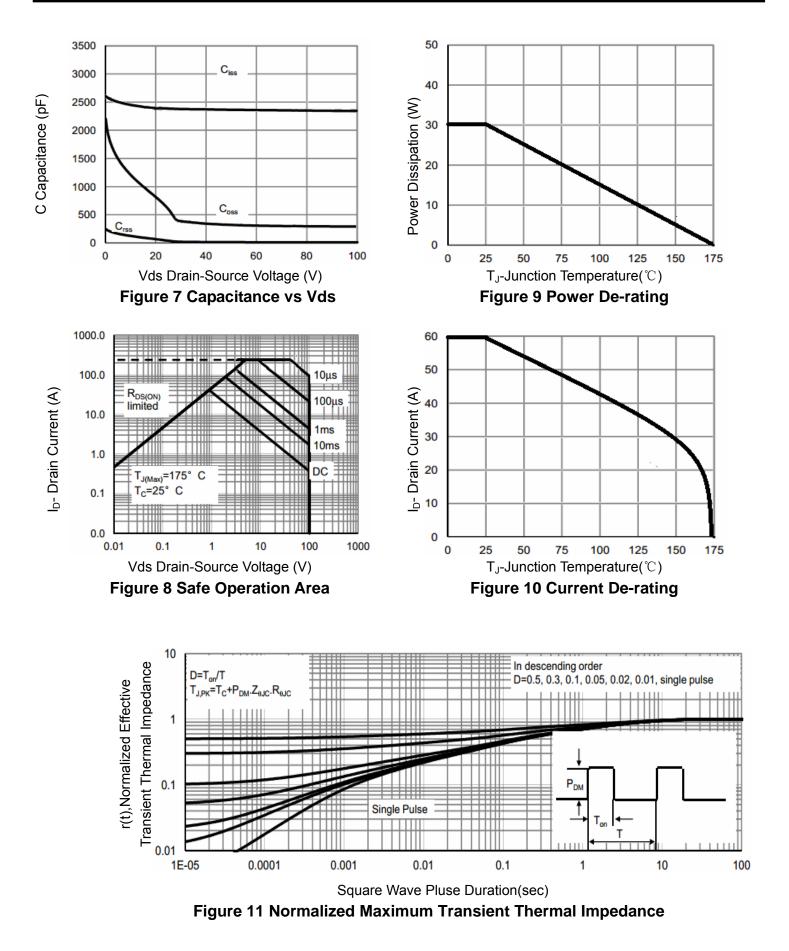
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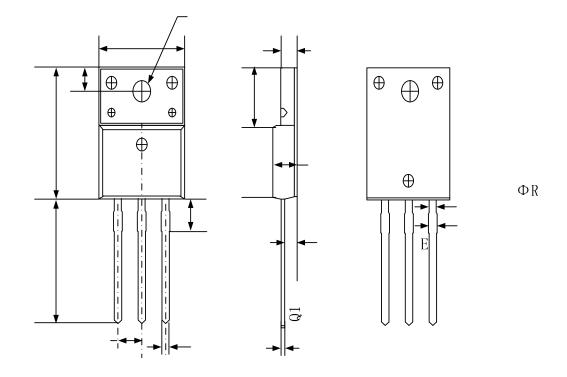




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TO-220F Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.50	4.83	0.18	0.19	
b	0.70	0.91	0.03	0.04	
b1	1.20	1.47	0.05	0.06	
b2	1.10	1.38	0.04	0.05	
С	0.45	0.63	0.02	0.02	
D	15.67	16.07	0.62	0.63	
е	2.54 BSC		0.10 BSC		
E	9.96	10.36	0.39	0.41	
F	2.34	2.74	0.09	0.11	
G	6.48	6.90	0.26	0.27	
L	12.68	13.30	0.50	0.52	
L1	3.13	3.50	0.12	0.14	
Q	2.56	2.93	0.10	0.12	
Q1	3.20	3.40	0.13	0.13	
ΦR	3.08	3.28	0.12	0.13	

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